



## AOD410

### N-Channel Enhancement Mode Field Effect Transistor

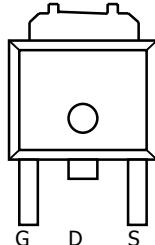
#### General Description

The AOD410 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  and low gate charge. This device is suitable for use as a load switch or in PWM applications.

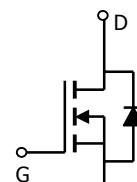
#### Features

$V_{DS}$  (V) = 30V  
 $I_D$  = 8A  
 $R_{DS(ON)} < 65m\Omega$  ( $V_{GS} = 10V$ )  
 $R_{DS(ON)} < 100m\Omega$  ( $V_{GS} = 4.5V$ )

TO-252  
D-PAK



Top View  
Drain Connected to Tab



#### Absolute Maximum Ratings <sup>A</sup>-25°C unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>F</sup>	$I_D$	8	A
$T_A=70^\circ C$		6	
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	20	
Power Dissipation <sup>A</sup>	$P_D$	4.2	W
$T_A=70^\circ C$		2.6	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 175	°C

#### Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	24	30	°C/W
Steady-State		45	60	°C/W
Maximum Junction-to-Case <sup>C</sup>	$R_{\theta JL}$	8	12	°C/W

**Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
<b>STATIC PARAMETERS</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	30			V
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{DS}=24\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$			1 5	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1	1.8	3	V
$I_{\text{D(ON)}}$	On state drain current	$V_{GS}=4.5\text{V}, V_{DS}=5\text{V}$	15			A
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=8\text{A}$ $T_J=125^\circ\text{C}$		48 76	65 100	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=6\text{A}$		75	100	$\text{m}\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{DS}=5\text{V}, I_D=8\text{A}$		6.2		S
$V_{\text{SD}}$	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.75	1	V
$I_S$	Maximum Body-Diode Continuous Current				4.3	A
<b>DYNAMIC PARAMETERS</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$		288		pF
$C_{\text{oss}}$	Output Capacitance			57		pF
$C_{\text{rss}}$	Reverse Transfer Capacitance			39		pF
$R_g$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$		3		$\Omega$
<b>SWITCHING PARAMETERS</b>						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, I_D=8\text{A}$		6.72		nC
$Q_g(4.5\text{V})$	Total Gate Charge			3.34		nC
$Q_{\text{gs}}$	Gate Source Charge			0.76		nC
$Q_{\text{gd}}$	Gate Drain Charge			1.78		nC
$t_{\text{D(on)}}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=15\text{V}, R_L=1.8\Omega, R_{\text{GEN}}=3\Omega$		3.7		ns
$t_r$	Turn-On Rise Time			3.7		ns
$t_{\text{D(off)}}$	Turn-Off Delay Time			15.6		ns
$t_f$	Turn-Off Fall Time			2.6		ns
$t_{\text{rr}}$	Body Diode Reverse Recovery Time	$I_F=8\text{A}, dI/dt=100\text{A}/\mu\text{s}$		12.6		ns
$Q_{\text{rr}}$	Body Diode Reverse Recovery Charge	$I_F=8\text{A}, dI/dt=100\text{A}/\mu\text{s}$		5.1		nC

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The power dissipation is provided based on the maximum value of  $R_{\theta JA}$  for  $t<10\text{s}$ .

B: Repetitive rating, pulse width limited by junction temperature.

C. The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to case  $R_{\theta JC}$  and case to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using 300 $\mu\text{s}$  pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

F. The maximum current rating is either limited by bond-wires, or set by steady-state  $R_{\theta JC}$ .

## TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

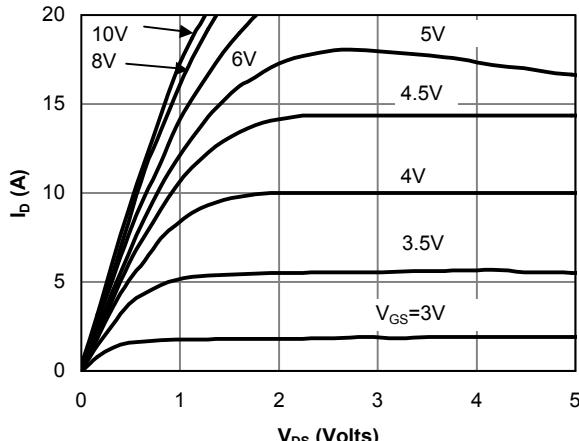


Fig 1: On-Region Characteristics

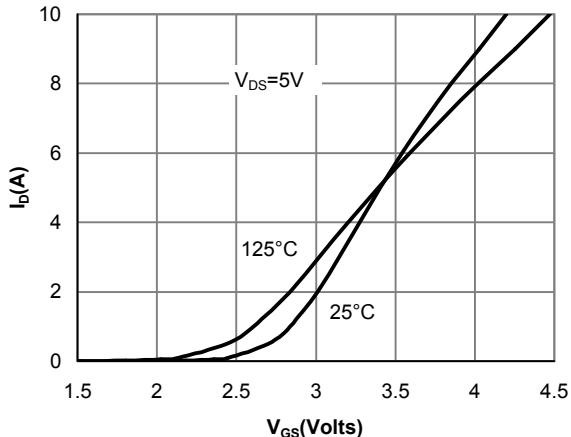


Figure 2: Transfer Characteristics

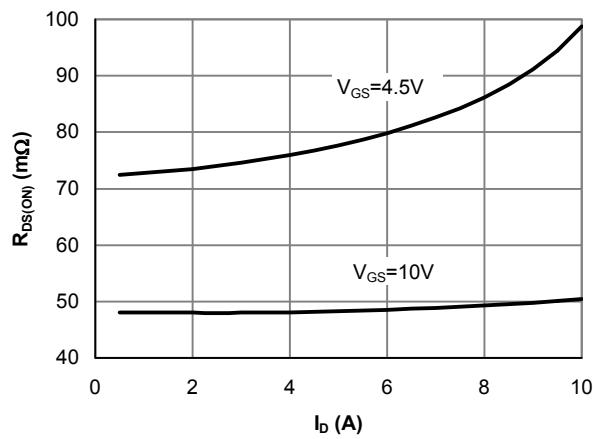


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

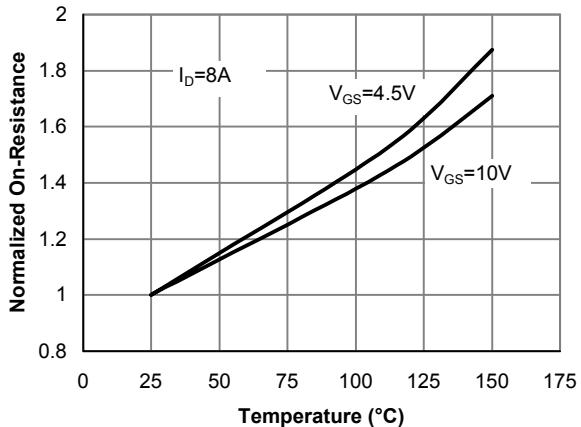


Figure 4: On-Resistance vs. Junction Temperature

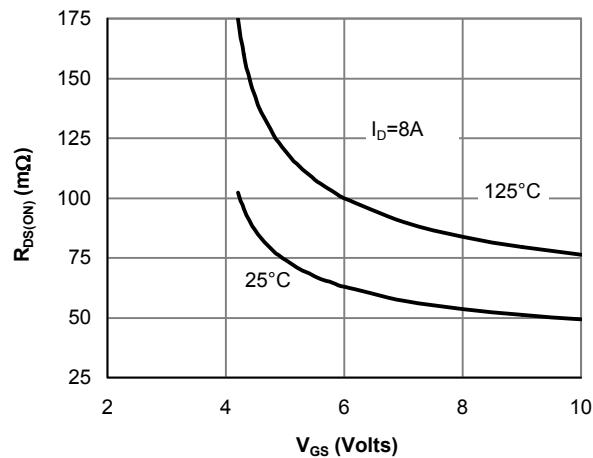


Figure 5: On-Resistance vs. Gate-Source Voltage

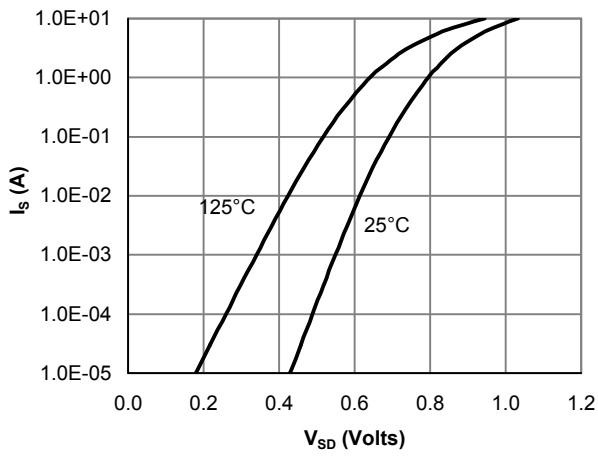


Figure 6: Body-Diode Characteristics

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